

Date: August 18, 2026

To
BSE Limited
P J Towers,
Dalal Street,
Mumbai – 400 001
Scrip Code: 544318

To
The National Stock Exchange of India Limited
“Exchange Plaza”,
Bandra – Kurla Complex,
Bandra (E), Mumbai – 400 051
Scrip Code: MAMATA

Dear Sir,

Sub: Disclosure under Regulation 30 of SEBI (Listing obligations and Disclosure requirements) Regulations, 2015 (“SEBI Listing Regulations”) - Intimation for Filing of Patent

Dear Sir,

Pursuant to Regulation 30 of the SEBI (Listing Obligations and Disclosure Requirements) Regulations, 2015, we wish to inform you that Mamata Machinery Limited (“Mamata” or “the Company”) has filed a patent application with the Indian Patent Office for its Die and Screw Design, which forms a core technology for the Company’s Recyclable Film Technology (“RecTech”).

The filing of the patent application represents an initiative by the Company towards protecting its intellectual property relating to the aforesaid technology.

You are requested to take the same on your record.

Thanking You

Yours Faithfully,

For, Mamata Machinery Limited

Madhuri Sharma
Company Secretary & Compliance Officer

MAMATA MACHINERY LIMITED

(Formerly Known as Mamata Machinery Private Limited)

(CIN: L29259GJ1979PLC003363)

Regd. Office: Survey No.423/P, Sarkhej-Bavla Road, Moraiya, Tal: Sanand, Dist: Ahmedabad-382213, Gujarat, India

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